
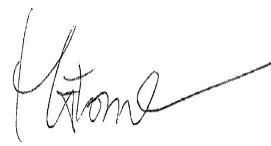


APPROVAL SHEET

Customer Name : _____
Customer P/N : _____
Frequency : 10.000000 MHz
Aker Approved P/N : VTOF-010000-3-D4-00
Aker MPN : VTOF-010000-3-D4-00
Rev. : 1
ISSUE DATE : Feb.13.2023

| APPROVED | CHECKED | PREPARED |
|---|---------|---|
|  | |  |
| APPROVED BY CUSTOMER | | |
| | | |

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MSL:Level 1
RoHS compliant



| | | | |
|---------------------|---|---------------------|----------------|
| Aker Approved P/N : | | VTOF-010000-3-D4-00 | |
| APPROVED | : | Tin | SHEET : 2 of 8 |
| PREPARED | : | Hitome | REV. : 1 |
| | | | Confidential |

SMD Temperature compensated crystal oscillator

1. ELECTRICAL CHARACTERISTICS

■ Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurement and tests are as follow :

Ambient temperature : 25±5 °C

Relative humidity : 40%~70%

If there is any doubt about the results, measurement shall be made within the following limits :

Ambient temperature : 25±3 °C

Relative humidity : 40%~70%

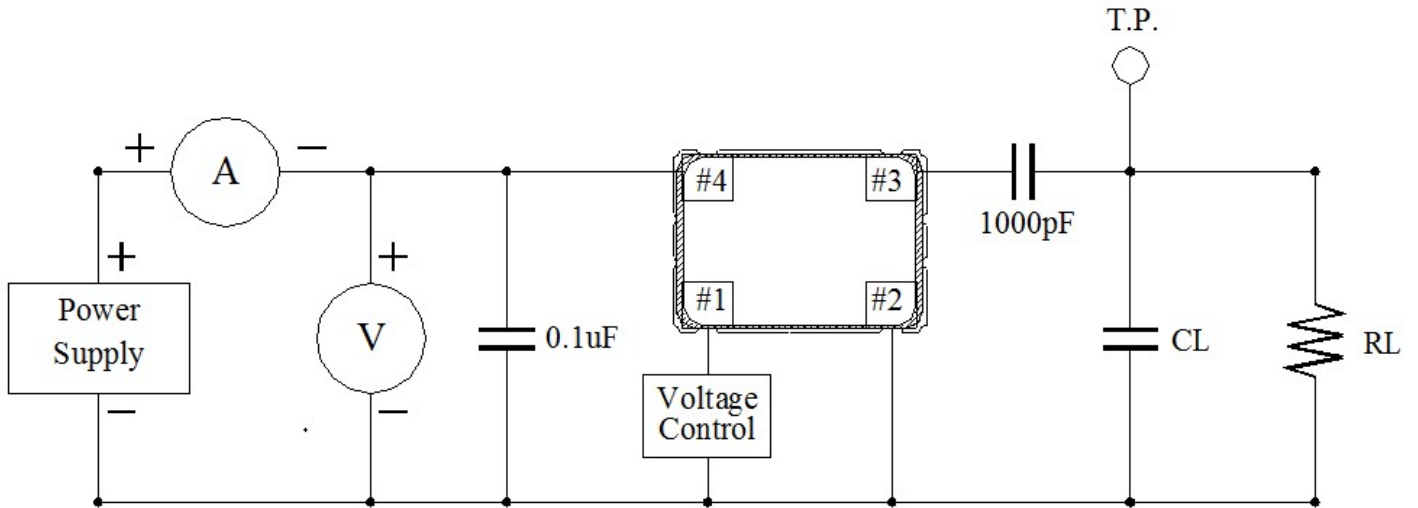
■ AKER Model : VTOF-321

■ Cutting Mode : AT CUT

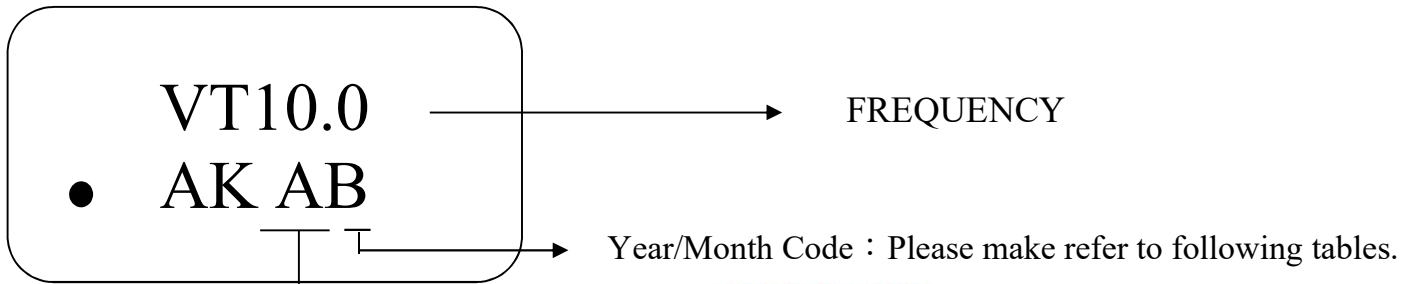
| Parameters | Electrical Spec | | | | Notes |
|---------------------------------------|-------------------|------|-------|-----------------|---|
| | Min. | Typ. | Max. | Units. | |
| Nominal Frequency | 10.000000 | | | MHz | |
| Supply voltage | 3.135 | 3.3 | 3.465 | V | |
| Nominal Frequency Tolerance | -1.5 | ~ | 1.5 | ppm | After 2 times reflow soldering |
| Frequency stability over temperature | -2.0 | ~ | 2.0 | ppm | Between minimum and maximum frequency value over the specified temperature range. |
| Supply voltage stability | -0.2 | ~ | 0.2 | ppm | |
| Load sensitivity | -0.2 | ~ | 0.2 | ppm | ±10% Load change |
| Load | 10//10 | | | KΩ//pF | |
| Temperature range | -40 | ~ | 85 | °C | |
| Storage temperature range | -40 | ~ | 85 | °C | |
| Current Consumption | | | 2.0 | mA | |
| Output Waveform | Clipped Sine Wave | | | | |
| Output voltage level | 0.8 | | | V _{pp} | |
| VCTL | 0.5 | 1.5 | 2.5 | V | Positive slope(df/dv) |
| Pulling Range | ±8 | | ±15 | ppm | |
| Vcon input impedance | 500 | | | KΩ | |
| Aging | -1.0 | ~ | 1.0 | ppm | First Year |
| Typical SSB phase noise power density | | -114 | | dBc/Hz | 100Hz offset. |
| Typical SSB phase noise power density | | -131 | | dBc/Hz | 1KHz offset. |
| Typical SSB phase noise power density | | -148 | | dBc/Hz | 10KHz offset. |

Please kindly be noted that AKER DO NOT guarantee parts quality which involves human security application.

2 . VCTCXO TESTING CIRCUIT



3. MARKING :



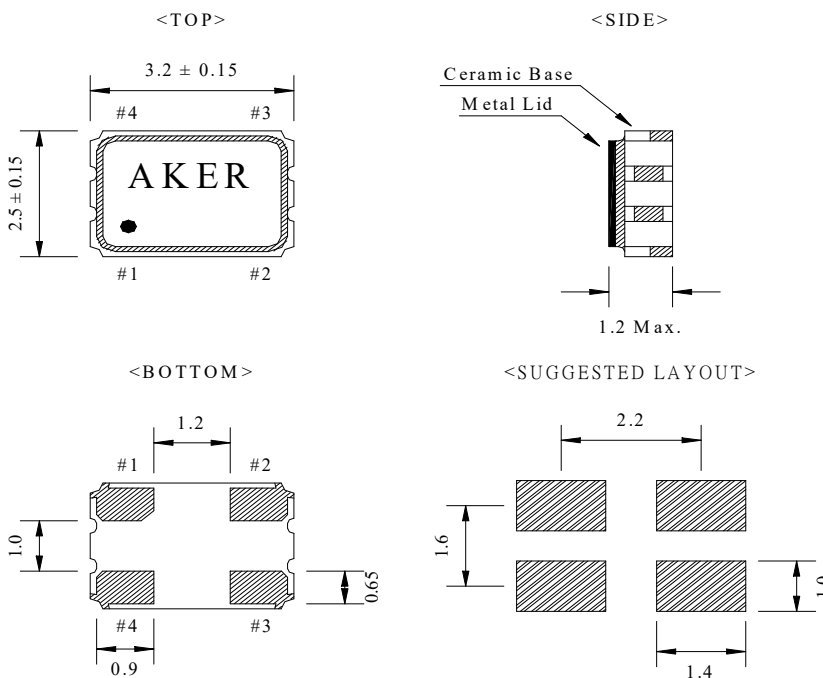
Date Code Guide

| Year | 2021 | 2022 | 2023 | 2024 |
|-------|--------|--------|--------|--------|
| | 2025 | 2026 | 2027 | 2028 |
| Month | (4N+1) | (4N+2) | (4N+3) | (4N+0) |
| JAN | a | n | A | N |
| FEB | b | p | B | P |
| Mar | c | q | C | Q |
| Apr | d | r | D | R |
| May | e | s | E | S |
| Jun | f | t | F | T |
| Jul | g | u | G | U |
| Aug | h | v | H | V |
| Sep | j | w | J | W |
| Oct | k | x | K | X |
| Nov | l | y | L | Y |
| Dec | m | z | M | Z |

A cycle every four years

4. DIMENSION :

(Unit : mm)

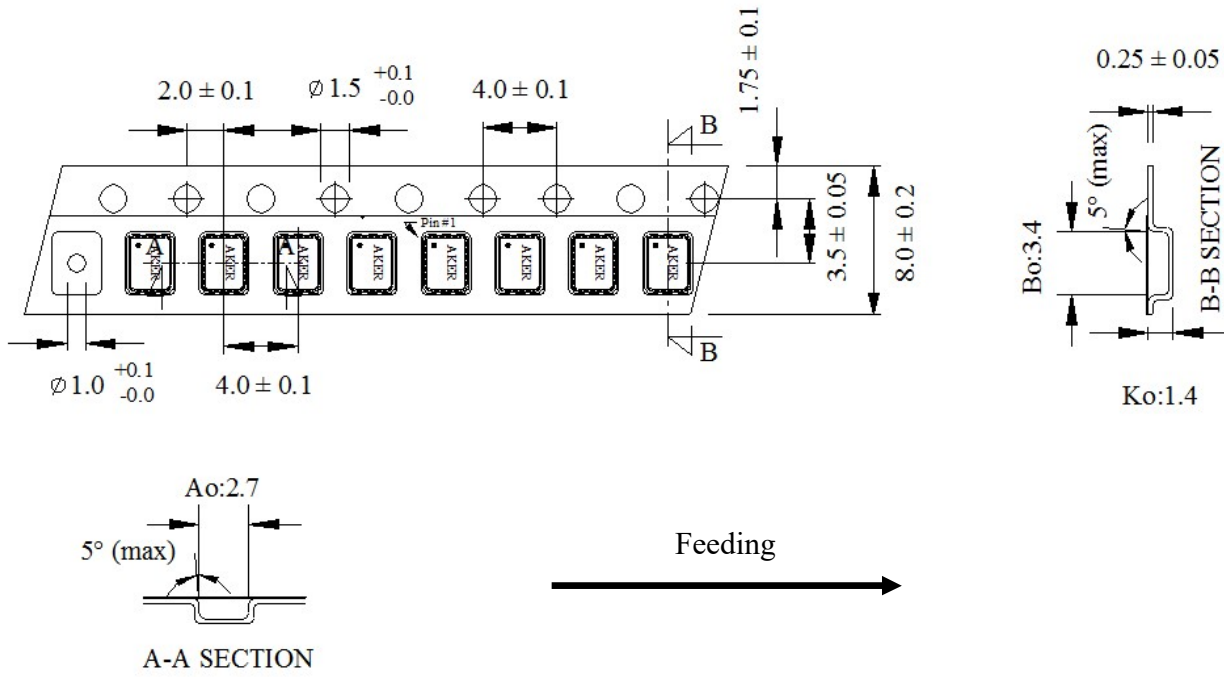


| Pad | Function |
|-----|----------|
| #1 | VCON |
| #2 | GND |
| #3 | Output |
| #4 | Vdd |

5. PACKING :

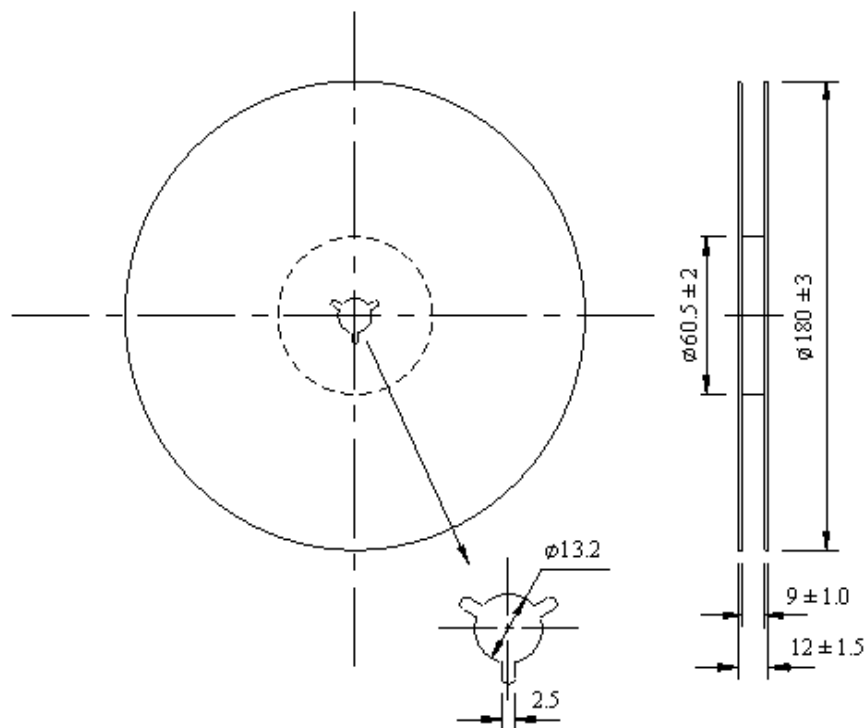
TAPE SPECIFICATION

(Unit : mm)

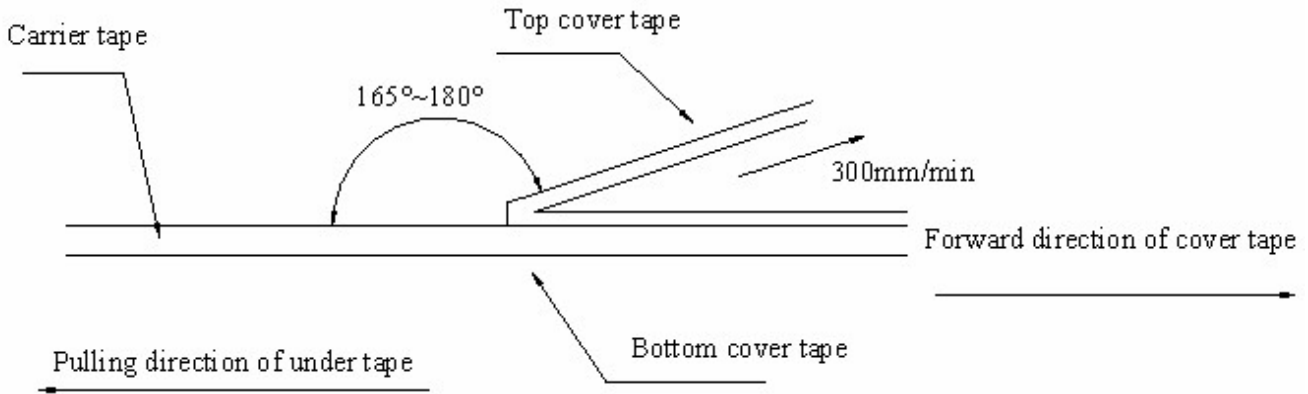


OUTLINE DIMENSION

(Unit : mm)



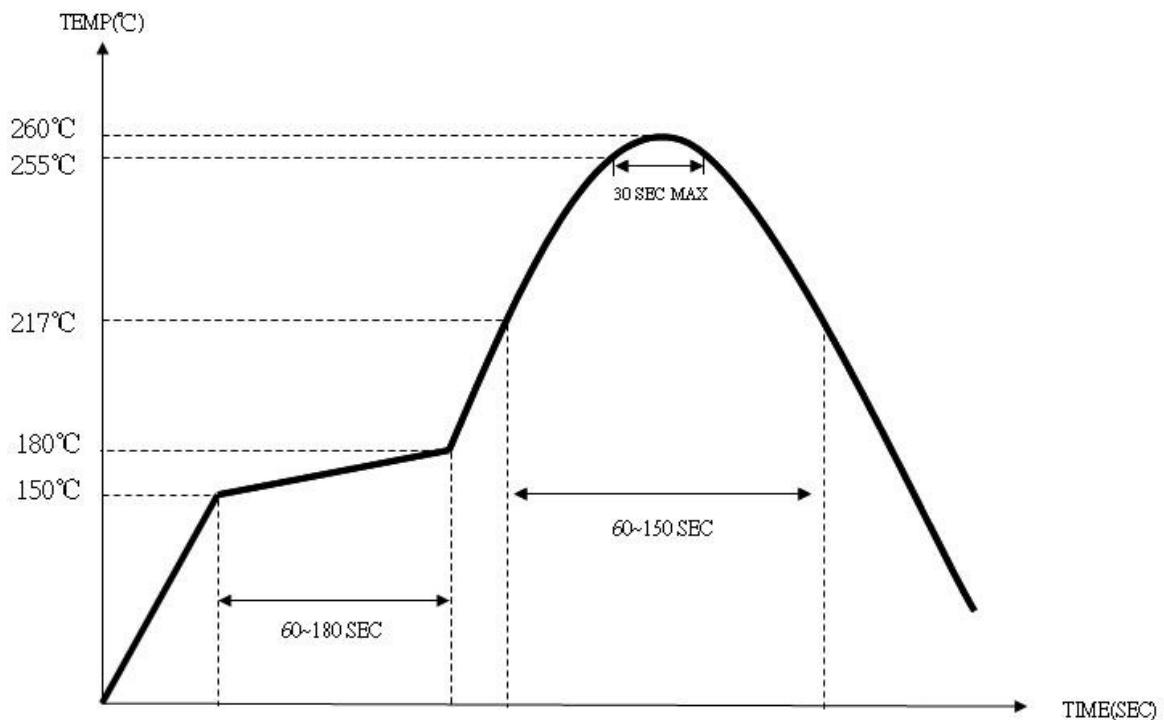
6. COVER TAPE ADHESION STRENGTH :



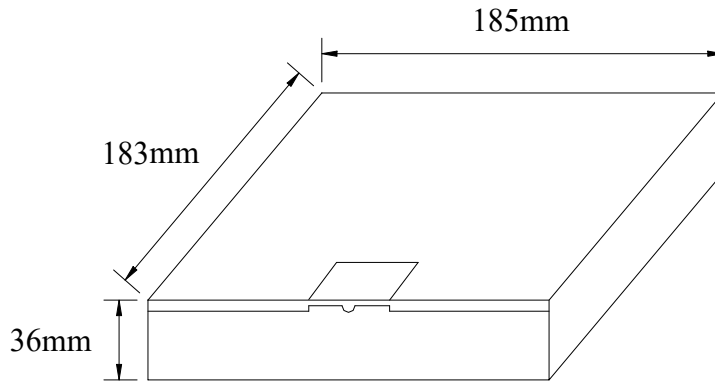
*** In the case, the cover tape is pulled off under the above conditions, the cover tape adhesion strength should be 10.2g~71.4g Plastic tape: 10.2g~71.4g

(Cover tape adhesion strength)

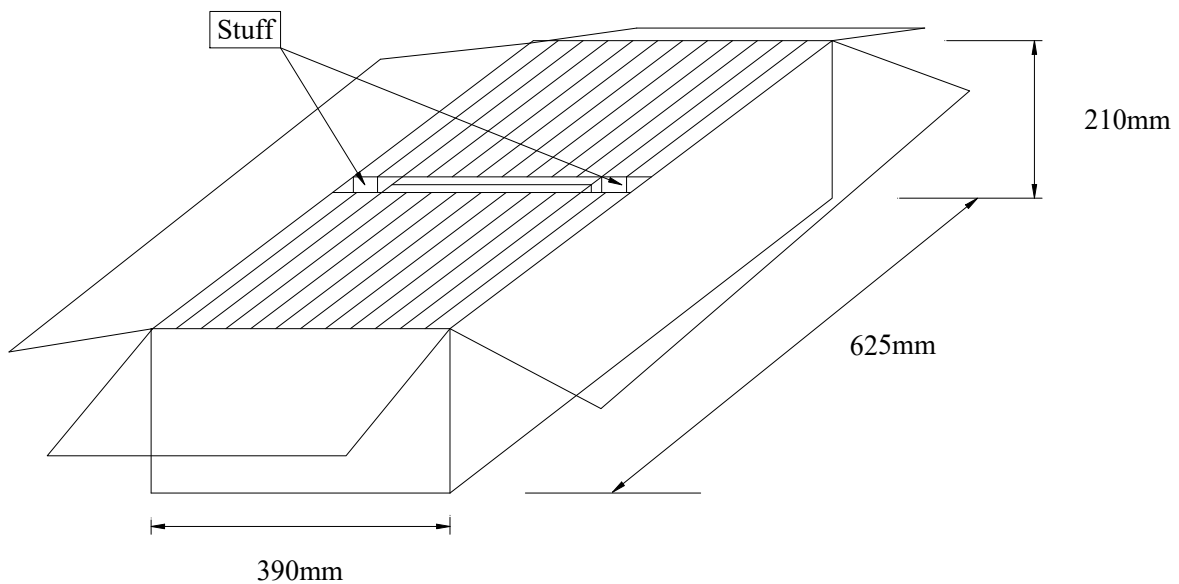
7. SOLDERING REFLOW PROFILE



8 . PACKING



BOX = 3000 PCS / REEL(MAX)



SMD product packs 32 BOX=The outside box packs (3000 PCS * 32 BOX = 96000 PCS)(MAX)



| | | | |
|---------------------|---------------------|----------------|--|
| Aker Approved P/N : | VTOF-010000-3-D4-00 | | |
| APPROVED : | Tin | SHEET : 8 of 8 | |
| PREPARED : | Hitome | REV . : 1 | |
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9 .RELIABILITY SPECIFICATION

Mechanical Endurance

| TEST ITEMS | TEST METHODS AND TEST CONDITION | PERFORMANCE |
|---------------------------------------|--|-------------|
| 9.1 Temperature Cycling | -40±3°C/30min maximum~+85±3°C/30min maximum , 1000cycles | ΔF≤±2ppm |
| 9.2 Operational Life | 85°C±3°C , 1000hrs±12hrs Rated VDD applied. | ΔF≤±2ppm |
| 9.3 Biased Humidity | 85°C±5°C&85%±5%R.H. , 1000±12hrs Rated VDD applied. | ΔF≤±2ppm |
| 9.4 Resistance To Soldering Heat Test | Reflow test 2 times. | ΔF≤±2ppm |
| 9.5 High Temperature Exposure | 85°C±3°C , 1000hrs±12hrs | ΔF≤±2ppm |
| 9.6 Vibration Test | Freq.range: 10~2000Hz , Peak to peak amplitude:1.52mm Peak acceleration:5G (49m/s2) , 3 direction(X, Y,Z) , 20min 12cycles each of 3 orientations. | ΔF≤±2ppm |
| 9.7 Mechanical Shock | 100G , 6mS , 3 times for each direction(X, Y, Z) , 3 cycles | ΔF≤±2ppm |
| 9.8 Physical Dimension | Verify physical dimensions to the applicable device detail specification. | |
| 9.9 Solderability | 260°C , Coated > 95% | |
| 9.10 Board Flex | PCB=100*40(mm) , Bending=2 mm (min) , Duration=60+5/-0 sec | ΔF≤±2ppm |
| 9.11 External Visual | Inspect device construction and marking. | |
| 9.12 Terminal Strength | A force of 17.7N for 60 seconds. | ΔF≤±2ppm |